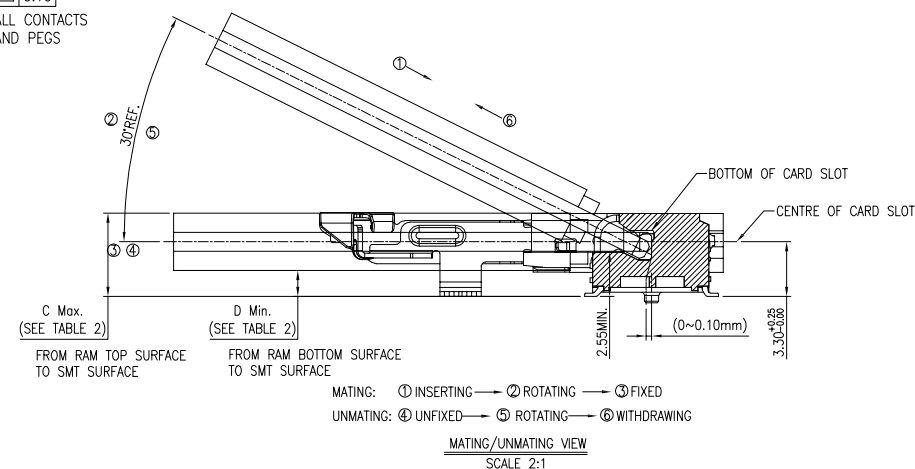
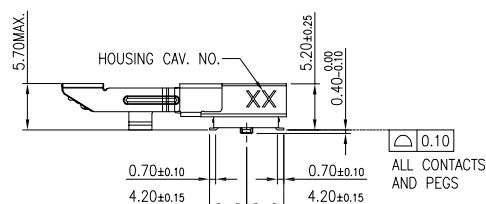
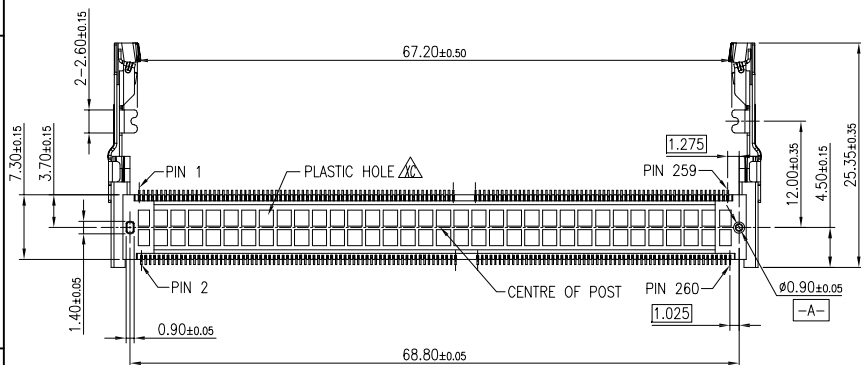
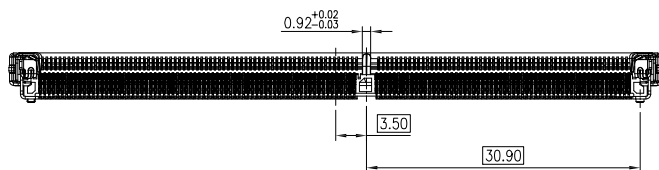
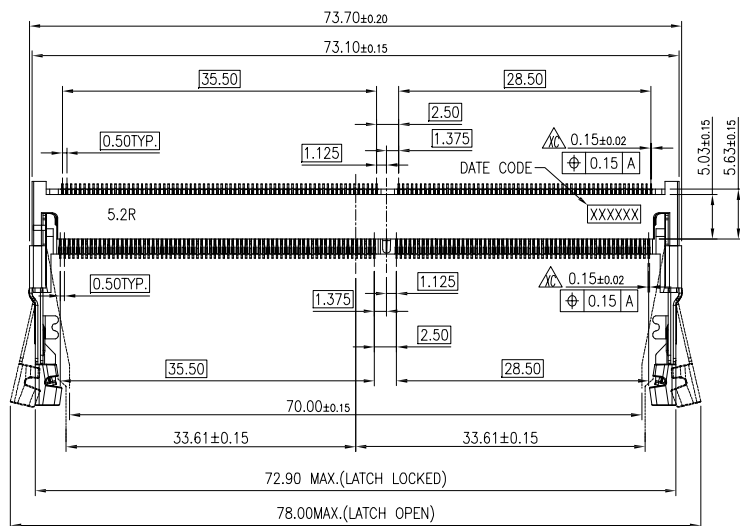




NOTES

1.MATERIAL

1-1 HOUSING: LCP THERMOPLASTIC. UL94V-0. COLOR: BLACK.

1-2 CONTACT: HIGH-PERFORMANCE COPPER ALLOY.

1-3 LATCH: STAINLESS STEEL.

1-4 PEG: STAINLESS STEEL.

2.FINISH

2-1 CONTACT: GOLD PLATING 1~3u" ON CONTACT AREA
AND 1~3u" GOLD PLATING ON SOLDER AREA
NICKEL 50u"~150u" UNDER-PLATING ALL OVER

2-2 PEG: 50~150u" TIN PLATING OVER
50~150u" NICKEL UNDER-PLATING ALL OVER

3.MSL LEVEL: MSL(MOISTURE SENSITIVITY LEVEL)=1.

4.IR REFLOW:

THE PEAK TEMPRATURE ON THE BOARD SHALL BE MAINTAINED FOR 10 SECONDS AT 260±5°C.

TOLERANCE		 东莞市友贸实业有限公司 DONGGUAN UMAX ENTERPRISE LIMITED		TITLE: DDR4 SODIMM 5.2H 260PIN REVERSE G/F TYPE.				
LINEAR	ANGLES			PART NO. D4260-5201RR				
X.±0.40	X°.± 3°			DWG NO. C-D4260-52R				
.X±0.30	.X°±	APPD: Jason	MAT'L:		UNITS	SCALE	SHEET	REV
.XX±0.20	.XX°±	CHKD: Schumi	FINISH:		MM	1 : 1	1 OF 2	A0
.XXX±0.10	.XXX°±	DRWN:Lei Songping	Q'TY:					

